

Features

- Low profile package
- Ideal for automated placement
- Low power losses, high efficiency
- Low forward voltage drop
- High surge capability
- High temperature soldering:
260°C/10 seconds at terminals
- Component in accordance to
RoHS 2002/95/1 and WEEE 2002/96/EC



SMB (DO-214AA)

Mechanical Data

- **Case:** JEDEC DO-214AA molded plastic
- **Terminals:** Solder plated, solderable per
JESD22-B102D
- **Polarity:** Laser band denotes cathode end

Major Ratings and Characteristics

$I_{F(AV)}$	3.0A
V_{RRM}	20 V to 200 V
I_{FSM}	100A
V_F	0.50V, 0.55V, 0.70V, 0.85V, 0.95V
$T_{jmax.}$	125 °C

Maximum Ratings & Thermal Characteristics

($T_A = 25\text{ °C}$ unless otherwise noted)

Items	Symbol	SS32	SS33	SS34	SS35	SS36	SS38	SS310	SS315	SS320	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	20	30	40	50	60	80	100	150	200	V
Maximum RMS voltage	V_{RMS}	14	21	28	35	42	56	70	105	140	V
Maximum DC blocking voltage	V_{DC}	20	30	40	50	60	80	100	150	200	V
Maximum average forward rectified current	$I_{F(AV)}$	3									A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	100									A
Voltage rate of change (rated V_R)	dv/dt	10000									V/μs
Thermal resistance from junction to lead (1)	$R_{θJL}$	25									°C/W
Operating junction and storage temperature range	T_J, T_{STG}	-65 to +125									°C

Note 1: Mounted on P.C.B. with 0.28 x 0.28" (7.0 x 7.0mm) copper pad areas.

Electrical Characteristics

($T_A = 25\text{ °C}$ unless otherwise noted)

Items	Test conditions		Symbol	SS32	SS33~34	SS35~36	SS38~310	SS315~320	UNIT
Instantaneous forward voltage	$I_F=3.0A^{(2)}$		V_F	0.50	0.55	0.70	0.85	0.95	V
Reverse current	$V_R=V_{DC}$	$T_j=25^{\circ}C$	I_R	0.5					mA
		$T_j=100^{\circ}C$		5.0					

Note 2: Pulse test: 300μs pulse width, 1% duty cycle.

Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

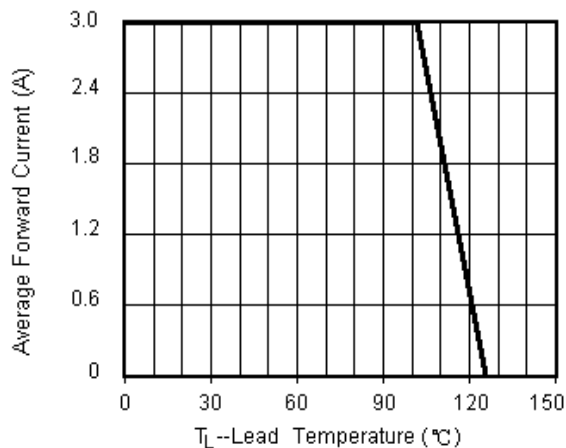


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

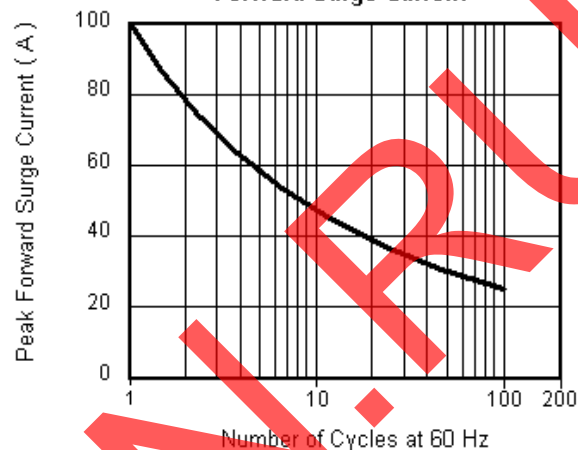


Fig.3 Typical Instantaneous Forward Characteristics

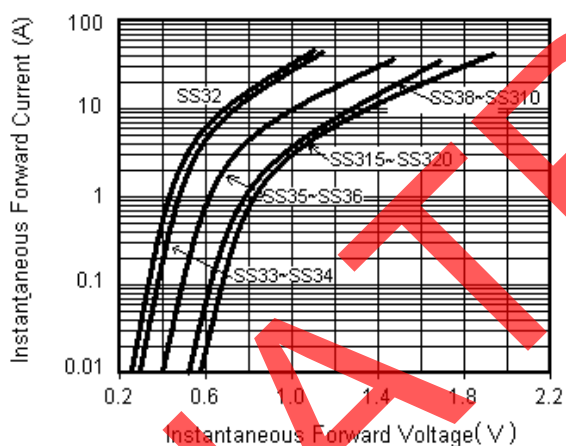
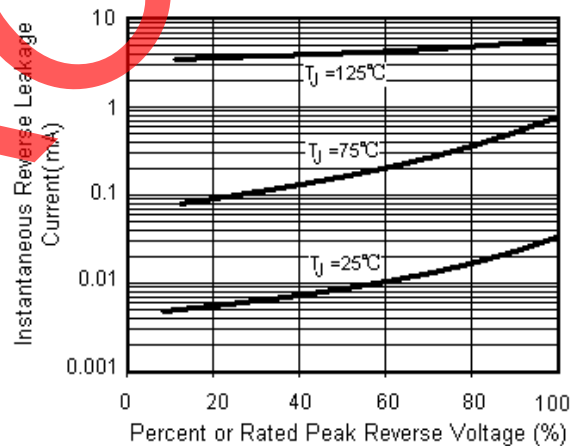
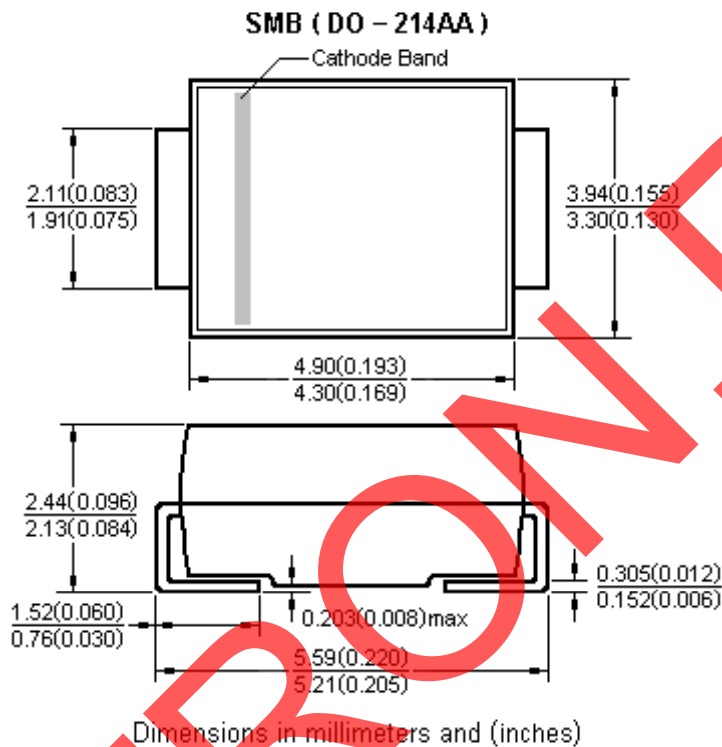


Fig.4 Typical Reverse Leakage Characteristics



Package Outline



Notice

- Product is intended for use in general electronics applications.
 - Product should be worked less than the ratings; if exceeded, may cause permanent damage or introduce latent failure mechanisms.
 - The absolute maximum ratings are rated values and must not be exceeded during operation. The following are the general derating methods you design a circuit with a device.
- $I_{F(AV)}$: We recommend that the worst case current be no greater than 80% .
- T_J : Derate this rating when using a device in order to ensure high reliability. We recommend that the device be used at a T_J of below 100°C.

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